

COMPACT AI Vehicle Series

Computer Vision Edge Unit with NVIDIA Jetson Xavier NX

optional
LTE / GNSS / Wi-Fi



2x USB 2.0
microSD
DisplayPort

Image similar

Power Supply
9 ... 45VDC

CAN

2x GBit LAN

USB 3.1

HDMI

IPC/COMPACT A3N - RS

This fanless COMPACT A3N generation is based on the NVIDIA Jetson Xavier NX processor module and offers a wide range of interface options.

The robust and uncompromising industrial design allows the implementation in the most demanding mobile AI applications and guarantees long term availability.

- 24/7 continuous operation
- Extended AI Computing
- Passively cooled, no moving parts
- Long term availability with fixed BOM

 **NVIDIA.** Linux for Tegra (L4T)

Product Highlights

Maintenance free
Power Ignition Controller
Shock and vibration resistant
LTE, GNSS and Wi-Fi connectivity options
No moving parts / passively cooled

Product Features

384-core NVIDIA Volta™ GPU
with 48 Tensor Cores
6-Core ARM v8.2 64-bit NVIDIA Carmel CPU
8GB / 16GB 128-bit LPDDR4x RAM
M.2 NVMe slot for storage expansion up to 2TB
USB 3.1 and HDMI 2.0 ports with dust covers
Ethernet, passive or active CAN
LTE, GNSS & WiFi
Aluminum & Stainless steel housing
Protection class IP65

Industries / Applications

Autonomous Mobile Robots (AMRs)
Automotive
Transportation
Robotics
Agriculture
Construction Vehicles

| Processor module / Performance | | |
|--|-------------------|-------------------|
| NVIDIA Jetson Xavier NX 384-core NVIDIA Volta™ GPU with 48 Tensor Cores 6-Core ARM v8.2 64-bit NVIDIA Carmel CPU | • | • |
| NVIDIA Jetson Xavier NX (16GB RAM) 384-core NVIDIA Volta™ GPU with 48 Tensor Cores 6-Core ARM v8.2 64-bit NVIDIA Carmel CPU | optional | optional |
| AI Performance (INT8) | 21 TOPs | 21 TOPs |
| Memory / Storage | | |
| Data Cache Size | 2MB | 2MB |
| 128-bit LPDDR4x RAM soldered on board | 8GB | 8GB |
| eMMC 5.1 Flash Storage on board | 16GB | 16GB |
| M.2 2280 Key M socket (for NVMe SSD) ⁵ | 1 | 1 |
| microSD card socket ² | 1 | 1 |
| Features | | |
| Real time clock (RTC) with battery backup Renata CR2477N (950mAh) | • | • |
| Inertial measurement unit (IMU) ¹ STMicroelectronics ISM330DHCXTR | on request | on request |
| Communication Interfaces | | |
| Display output <small>behind the service cover</small> | DisplayPort 1.4 | DisplayPort 1.4 |
| Internal USB version 2.0 OTG <small>behind the service cover</small> (micro USB Type AB) | 1 | 1 |
| USB version 2.0 <small>behind the service cover</small> (Type A) | 2 | 2 |
| Display output | HDMI 2.0 | HDMI 2.0 |
| USB version 3.1 (5 Gbit/s) (Type A) | 1 | 1 |
| Ethernet 10/100/1000 BASE-T (1x native, 1x I210-IT) (M12 female, x-coded) | 2 | 2 |
| CAN 2.0A / CAN 2.0B (active/passive), CAN FD supported, isolated (M12 female, a-coded) | 1 | 1 |
| Mini PCIe socket ² , used for extensions depending on configuration | 2 | 2 |
| Serial RS232 ¹ (M12 female, a-coded) | optional | optional |
| USB version 2.0 ¹ (M12 female, a-coded) | optional | optional |
| MIPI CSI-2 / GMSL2 / FPDLinkIII Camera interface ¹ | on request | on request |
| Wireless Connectivity | | |
| Cellular 4G Module (LTE/UMTS/GSM) with built-in GNSS Telit LE910C4-WWX ⁶ (Dual nano SIM support) | none | 3x SMA |
| Wireless LAN IEEE 802.11a/b/g/n/ac dual-band 2x2 MIMO & Bluetooth 5.0 Emwicon WMX6218 ⁶ | none | 2x RP-SMA |
| High Accuracy GNSS Positioning Module w/ RTK & optional heading support ¹ u-blox ZED F9R / F9P | on request | on request |
| Technical Data | | |
| Dimensions [mm] (housing, excl. mounting) | w182 x h60 x d127 | w182 x h60 x d127 |
| Dimensions [mm] (housing, incl. mounting) | w218 x h60 x d127 | w218 x h60 x d127 |
| Net weight [gram] | ~ 1600 | ~ 1650 |
| Non isolated input voltage, with ignition controller, reverse polarity protected (M12 male, a-coded) | 9... 45VDC | 9... 45VDC |
| Power consumption typ. in Watt @ 24V without Add-Ins, idle | ~ 8.5 | ~ 8.5 |
| Environmental Conditions | | |
| Operating temperature ³ | -25°C ... +70°C | -25°C ... +70°C |
| Storage temperature | -25°C ... +85°C | -25°C ... +85°C |
| Ingress protection standard according to EN60529 | IP65 | IP65 |
| Conformal coating ⁴ | on request | on request |
| Shock (designed to meet) | EN60068-2-27 | EN60068-2-27 |
| Vibration (designed to meet) | EN60068-2-64 | EN60068-2-64 |
| EMC-Conformity | EN55032 / EN55035 | EN55032 / EN55035 |
| Safety (designed to meet) | EN62368-1 | EN62368-1 |
| Radio and Telecommunication (designed to meet) | n/a | RED |
| MTBF @ 25°C ambient <small>according to Telcordia SR-332, Environment GB, excluding battery and SSD</small> | ~ 530 000h | ~ 375 000h |

¹ Please contact factory for minimum order quantities² Internal connector³ Depending on installation situation and interface connection. Please see user documentation.⁴ On all possible components (excl. Xavier NX module, connectors and wireless devices)⁵ It is possible to equip the products with an Industrial grade Apacer PV210 NVMe SSD. Retrofitting an SSD is not possible by the user without complete disassembly. Use these part codes:

IPC/RSA3NI19-[E/F]10xS-01 = 120GB | IPC/RSA3NI19-[E/F]10xS-02 = 240GB | IPC/RSA3NI19-[E/F]10xS-05 = 480GB | IPC/RSA3NI19-[E/F]10xS-10 = 960GB

⁶ These LTE and Wi-Fi modules have replaced the previously used Sierra Wireless MC7455 and SparkLAN WPEB-263ACNI(BT) due to these modules going EOL (previous products: IPC/RSA3NI19-F102S)

Product specifications subject to change without notice. | All data is for information purposes only and not guaranteed for legal purposes. Information in this data sheet has been carefully checked and is believed to be accurate. However, no responsibility is assumed for inaccuracies. Please refer to the user documentation for additional product specification.

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